

Cite this: *RSC Adv.*, 2017, 7, 16104

# The enhancement of Hall mobility and conductivity of CVD graphene through radical doping and vacuum annealing†

Viet Phuong Pham,<sup>\*ab</sup> Anurag Mishra<sup>ac</sup> and Geun Young Yeom<sup>\*ab</sup>

We report an innovative method for chlorine doping of graphene utilizing an inductively coupled plasma system. TEM analysis reveals that the pre-doping (doping before wet transfer) and normal-doping (doping after wet transfer) were generally formed and trapped well between graphene layers; moreover, by thermal stability testing, the chlorine-trapped layer-by-layer graphene showed a very high thermal stability in vacuum at 230 °C for 100 hours. We also obtained the sheet resistance and optical transmittance of the Cl-trapped tri-layer graphene at 72  $\Omega$  sq<sup>-1</sup> and 95.64% at 550 nm wavelength, respectively. In addition, the high hole mobilities for the chlorine-trapped bi- and tri-layer graphene were observed up to 3352 and 3970 cm<sup>2</sup> V<sup>-1</sup> s<sup>-1</sup>, respectively.

Received 1st February 2017

Accepted 21st February 2017

DOI: 10.1039/c7ra01330b

rsc.li/rsc-advances

## Introduction

Graphene has attracted significant interest due to its exotic characteristics such as high mobility, high transmittance (% *T*), and excellent thermal and electrical conductance.<sup>1–3</sup> However, for many applications, graphene in its pristine form cannot be used due to the absence of a band-gap and high sheet resistance ( $R_s$ ).<sup>4</sup> Graphene synthesized using thermal chemical vapor deposition (CVD) and other methods show high  $R_s$  and low conductivity. Therefore,  $R_s$  reduction and conductivity enhancement of graphene are exciting topics.<sup>5–8</sup>

Doping is one of the best methods for  $R_s$  reduction using chemical doping<sup>6,9,10</sup> and plasma doping.<sup>11–13</sup> In the case of chemical doping, a layer-by-layer doping of 3 layers thin graphene films with AuCl<sub>3</sub> yields a significant reduction in  $R_s$ ; however, it shows a sacrifice in the % *T* of the 3-layer doped graphene assembly (85%).<sup>9</sup> In addition, Tongay *et al.* presented p-type bis(trifluoromethanesulfonyl)amide doping of graphene with a significant reduction in the  $R_s$  value (425 to 129  $\Omega$  sq<sup>-1</sup>) and % *T* of ~87%.<sup>14</sup> However, the limitation of chemical doping is that it has no long stability and the remaining chemical residues induce a deterioration in device performance.<sup>6</sup>

To date, there are no methods for the complete removal of chemical residues and these cannot be removed even *via*

chemical methods (acid), physical methods (Ar plasma cleaning) or both.<sup>14–26</sup> The existence of polymer residues or defects is inevitable because of the imperfect origin of CVD graphene. For instance, poly(methyl methacrylate) (PMMA) and contaminants can be attached at the edges of wrinkles, at the graphene domains, at grain boundaries,<sup>27</sup> or bent graphene surfaces due to the highly rough Cu and imperfect processing during their synthesis.<sup>28</sup>

Plasma doping is an effective way to tune the graphene properties, as shown in a previous report.<sup>11</sup> Chlorine (Cl) plasma is the most controllable factor for graphene doping and can produce non-destructive doping with increased electrical conductivity.<sup>12</sup> The true potential of graphene lies in photonics and optoelectronics with exotic electronic and optical characteristics. This requires a very low  $R_s$  value for graphene with no degradation in transparency. Herein, we proposed a method based on an innovative inductively coupled plasma (ICP) system, which is of low energy and non-damaging<sup>29</sup> for Cl-doping in graphene with very low  $R_s$  values, extremely high transparency, high thermal stability, and high mobility.

## Results and discussion

Monolayer graphene was grown on Cu *via* a CVD approach, as described in detail in a previous report.<sup>29</sup> To optimize the Cl-doping effect, pre-doping (doping before wet transfer) on graphene/Cu, normal-doping (doping after wet transfer), and a combination of pre-doping and normal-doping on the graphene/substrate of PET and SiO<sub>2</sub> were carried out. After Cl pre-doping, graphene/Cu was coated with PMMA, Cu was etched using a FeCl<sub>3</sub> etchant over 45 min, and then transferred on PET and SiO<sub>2</sub>. Finally, the PMMA was removed by washing the material with acetone, IPA, and DI water. For Cl normal-doping and

<sup>a</sup>School of Advanced Materials Science and Engineering, Sungkyunkwan University (SKKU), Suwon, Gyeonggi-do 440-746, Republic of Korea. E-mail: pvphuong1985@gmail.com; gygyeom@skku.edu

<sup>b</sup>SKKU Advanced Institute of Nano Technology (SAINT), SKKU, Suwon, Gyeonggi-do 440-746, Republic of Korea

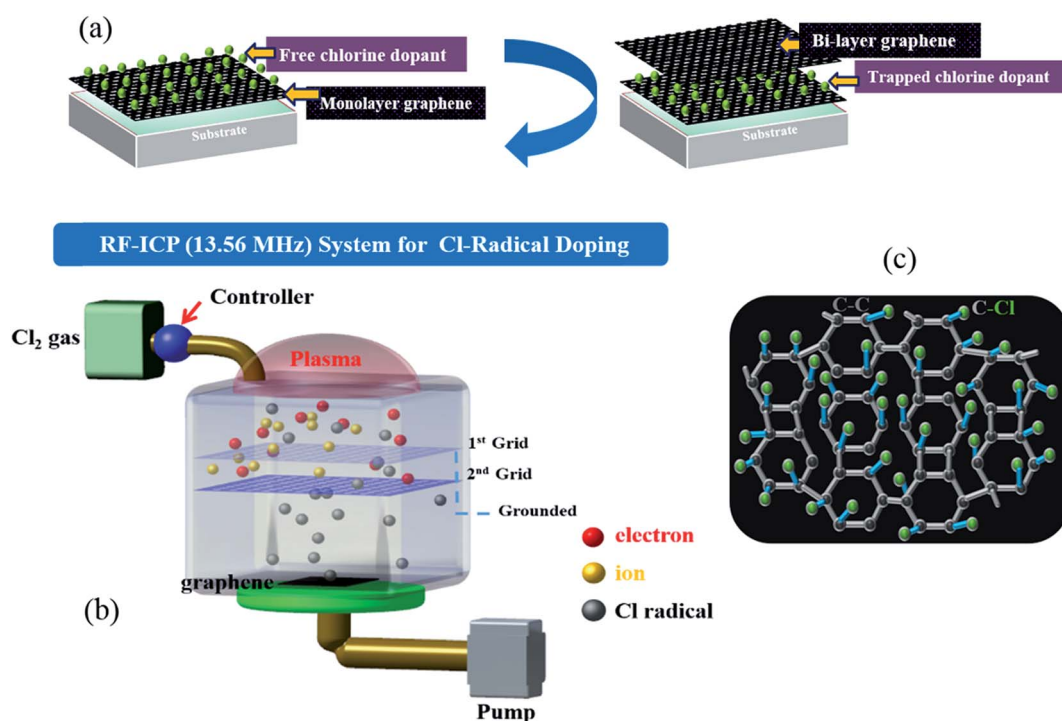
<sup>c</sup>Etch Division, Applied Materials Co., 77, Sunnyvale, California, 94085, USA

† Electronic supplementary information (ESI) available. See DOI: 10.1039/c7ra01330b

combined-doping, which were applied for Cl-doped mono-, Cl trap-doped bi-, and tri-layer graphene, the doping process was repeated until 3 layers of graphene were achieved. Fig. 1(a) shows the strategy of Cl-trap-doping on layer-by-layer graphene utilized in this study. An innovative ICP source was used in the present study, with a dual mesh assembly inserted between the source and substrate as shown in Fig. 1(b). Fig. 1(c) depicts the crystal structure of the chlorinated graphene with the formation of covalent C–Cl bonds on the CVD graphene surface. In this chlorine doping process, low energy radicals extracted from the chlorine plasma confined by a double-mesh grid system were used to prevent damage to graphene. When a Cl radical is adsorbed on the graphene surface, due to the strong electronegativity of Cl atom, an electron is transferred from the graphene surface to the attached Cl atom and an ionic bond between the graphene surface and Cl atom is formed without breaking the graphene structure. Generally, as previously reported,<sup>30</sup> during plasma doping, graphene is damaged by breaking the C–C bonds in graphene (the C–C bond strength in graphene is very low at 4.9 eV) due to ion bombardment during exposure to the plasma.<sup>30</sup> Herein, in the Cl plasma, we used a double mesh-grid to remove the ion energy bombardment during the Cl plasma operation and to prevent the breaking of graphene network by the ions. Generally, chlorine dopants adsorbed on a graphene film surface can be easily removed during handling of the graphene under various environmental conditions such as heating, moisture, oxygen, *etc.* However, with covalent bonding, when the defect-containing fresh graphene on Cu foil is exposed to chlorine plasma, it is expected that chlorine can be bonded to the defect sites in the form of

strong C–Cl bonds (such as covalent bonding), which may remain even after the transfer process. In this case of covalent bonding, no increase in the number of defects (such as no increase of the D peak intensity in Raman spectroscopy) was observed because the Cl is bonded to pre-existing defects, as presented in Pham *et al.*<sup>29</sup>

To observe the low energy Cl adsorption on the graphene surface and interface, TEM analysis was utilized. Fig. 2(a) and (b) show the DF-TEM images of a bi-layer graphene without/with Cl trap-doping. The white-colored clouds shown in Fig. 2(b) are believed to be the Cl atom locations caused by trap doping between the graphene layers. A thin network of white color is also shown in Fig. 2(a), which is believed to be the slight Cl-doping originating from the FeCl<sub>3</sub> etchant. The existence of Cl atoms was also proven by micro-EDS in TEM with the analysis points confirming that the Cl adsorbates were small (0.5%) and that they were sandwiched between two graphene layers, as shown in Fig. 2(c). In Fig. 2(c), the oxygen composition was increased from 0.96% (pristine bi-layer graphene) to 3.27% (Cl-trapped bi-layer graphene) because all our experiments were carried out in an air atmosphere; in addition, the layer-by-layer graphene transfer was *via* wet method (PMMA). Therefore, reactions occur between the experimental processes with the contaminants, impurities in the air or the residues during wet transfer and these contaminants or residues contain oxygen functional groups (OH<sup>−</sup>, COOH<sup>−</sup>, *etc.*), which are known as key factor in the deterioration of device performance. As the result, residues and impurities are inevitable during the CVD process of graphene, even a little bit. This is still a big challenge for 2D-materials research community. Recently, a promising method



**Fig. 1** (a) The strategy of Cl-trap doping on layer-by-layer graphene using the ICP system. (b) The low damage ICP source used in the present study, which is comprised of a dual mesh assembly inserted between the source and substrate. (c) An image of the crystal structure of chlorinated graphene with covalent C–Cl bonding.



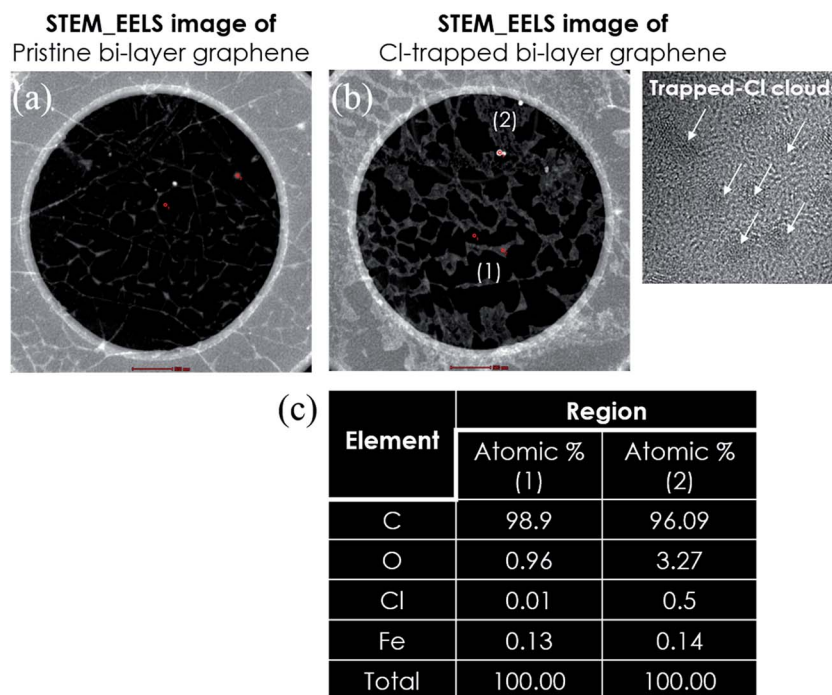


Fig. 2 TEM images (a and b) of pristine bi-layer graphene and the Cl-trapped bi-layer graphene. (c) Micro-EDS data of the atomic percentages in regions (1) and (2) of (b).

using the direct-growth of graphene on insulating substrates to avoid the wet transfer process was revealed and is still in progress.<sup>31</sup>

The Raman and XPS investigations used in this study have been investigated in detail in our previous report.<sup>29</sup> In addition, we also showed the Raman spectra of tri-layer graphene with/without p-type Cl-trap doping (see Fig. S1, ESI†). With Cl-trap doping, the tri-layer graphene showed the blue-right shift in the G and 2D peaks ( $1577$  and  $2679$   $\text{cm}^{-1}$ ) when compared with the G and 2D peaks in the without Cl-trap doping of tri-layer graphene ( $1574$  and  $2675$   $\text{cm}^{-1}$ ), indicating the Cl dopant as a p-type dopant on graphene. In other words, the Raman spectra showed a blue-shift of  $3$   $\text{cm}^{-1}$  and  $4$   $\text{cm}^{-1}$  in the G and 2D peaks, indicating the Cl dopant as a p-type dopant on graphene. In fact, an investigation of the blue-shifts in the peaks of the Raman spectra of few-layer graphene has been carried out in detail in previous reports.<sup>9,32</sup>

For the long-term stability testing of Cl trap-doping on graphene, a thermal annealing process was carried out (Fig. 3). In fact, we kept some of the doped graphene samples used for the experiment, which were made four months earlier and, therefore, the  $R_s$  values were re-measured. We found no change in the  $R_s$  values after exposure to an air environment for four months. The  $R_s$  values for  $130$   $\Omega$   $\text{sq}^{-1}$  of bi-layer graphene and  $72$   $\Omega$   $\text{sq}^{-1}$  of tri-layer graphene were measured. Moreover, the four-month-old-doped graphene samples were heated for  $100$  h in a vacuum furnace at  $230$   $^{\circ}\text{C}$  and, as shown in Fig. 3, no significant change in the  $R_s$  values was observed. Therefore, it is believed that the doped graphene samples prepared in our study are extremely stable.

Fig. 4(a) shows the Hall mobility values of the graphene samples without and with Cl-doping as a function of the  $R_s$  value. The Cl-doped mono-, bi-, tri-layer samples showed hole mobilities and  $R_s$  values of ( $2750$   $\text{cm}^2$   $\text{V}^{-1}$   $\text{s}^{-1}$ ,  $305$   $\Omega$   $\text{sq}^{-1}$ ), ( $3352$   $\text{cm}^2$   $\text{V}^{-1}$   $\text{s}^{-1}$ ,  $118$   $\Omega$   $\text{sq}^{-1}$ ), and ( $3970$   $\text{cm}^2$   $\text{V}^{-1}$   $\text{s}^{-1}$ ,  $72$   $\Omega$   $\text{sq}^{-1}$ ), respectively. Due to the Cl p-type doping effect, these doped results are much higher when compared to those without Cl-doping.

The explanation of the mechanism of Cl p-type doping has been presented in detail in our previous report (with the strongly covalent C–Cl bonds in the graphene lattice).<sup>29</sup> Due to

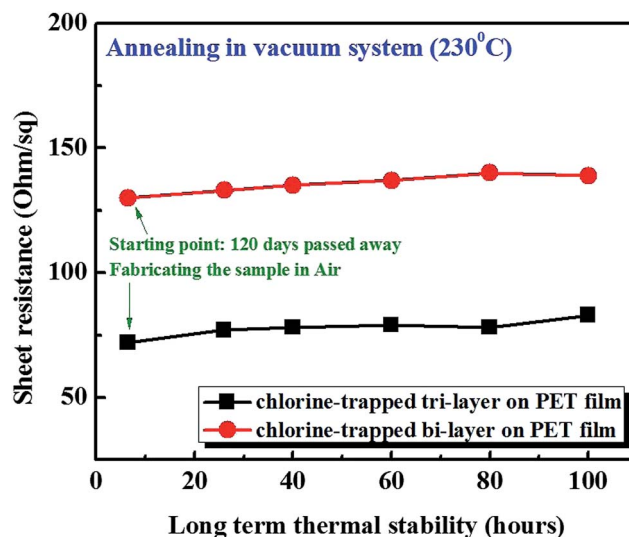


Fig. 3 Thermal stability testing of the Cl-trapped bi-layer and tri-layer graphene in a vacuum furnace.





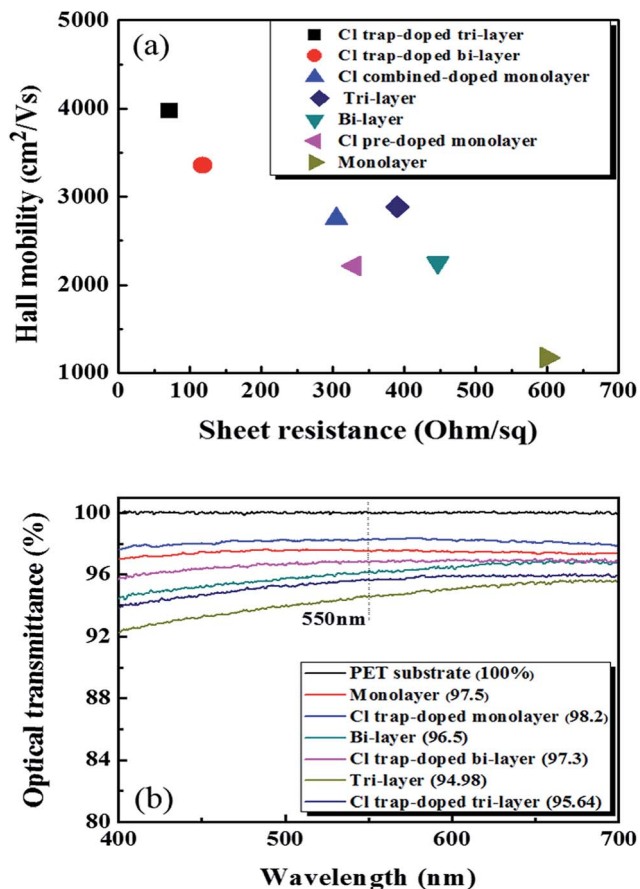


Fig. 4 (a) The Hall mobility values of graphene with/without Cl-doping as a function of the sheet resistance. (b) The optical transmittance of the graphene samples with/without Cl-doping.

the Cl p-type doping, the  $R_s$  value was decreased and led to an enhancement in the conductivity and Hall mobility of graphene. The correlations between the  $R_s$  value, conductivity and mobility are depicted in the formulas:  $R_s = \rho L/A$  and  $\rho = 1/\sigma = 1/(en\mu)$  where  $\rho$  is the resistivity,  $L$  is the length of the piece of graphene,  $A$  is the cross-sectional area of the specimen,  $\sigma$  is the conductivity,  $e$  is the electron,  $n$  is the carrier density, and  $\mu$  is the mobility. In fact, these correlations have been well-described by De *et al.*<sup>33</sup>

The high %  $T$  of graphene layer and low  $R_s$  value are very important in transparent electrode-based applications. Pham *et al.* obtained the best values for  $R_s$  and %  $T$  in doped mono-layer graphene on a PET substrate at  $240 \Omega \text{ sq}^{-1}$  and 97.7%, respectively.<sup>29</sup> Therefore, we measured the %  $T$  of the mono-, bi-, and tri-layer graphene on PET doped with Cl plasma and the results are shown in Fig. 4(b). The monolayer graphene doped with the optimized doping process (90 s of pre-doping and 120 s of normal-doping) showed a high %  $T$  of ~98.2% at 550 nm. For the bi-layer graphene and tri-layer graphene doped *via* cyclic trap doping using Cl plasma, we measured the %  $T$  at 97.3 and 95.64% at 550 nm, respectively. Because one monolayer graphene absorbs ~2.3% at 550 nm (ref. 34) and the light excitation of Cl atoms,<sup>35–37</sup> the %  $T$  of the doped mono- (98.2%), bi- (97.3%), and tri- (95.64%) layer graphene samples that we observed in the

experiments were a little higher than those of the undoped pristine mono- (97.5%), bi- (96.5%), and tri-layer graphene (94.98%) samples.

## Conclusions

In conclusion, we demonstrated the Cl-doping of graphene using an ICP system. Using TEM analysis, the Cl-trap doping strategy was generally formed well between the layer-by-layer graphene. Moreover, by thermal stability testing, the Cl-trapped layer-by-layer graphene showed a very high thermal stability in vacuum at 230 °C for 100 hours. We also obtained the  $R_s$  and %  $T$  of the Cl-trapped tri-layer graphene at  $72 \Omega \text{ sq}^{-1}$  and 95.64% at 550 nm, respectively. In addition, high hole mobilities of the Cl-trapped bi- and tri-layer graphene samples of up to 3352 and 3970  $\text{cm}^2 \text{ V}^{-1} \text{ s}^{-1}$ , respectively, were achieved. This study opens the promising potential for utilizing a combination of Cl pre-doping and normal-doping for transparent graphene electrode-based applications,<sup>38</sup> e.g. OLEDs, photodetectors, sensor, and solar cells.

## Experimental

Cu foil with an area of  $100 \times 90 \text{ cm}^2$  and thickness of 75  $\mu\text{m}$  was rolled into a CVD vacuum chamber made of quartz. First, the discharge chamber was filled with  $\text{H}_2$  gas at the flow rate of 10 sccm and then the Cu foil was annealed for 1 h at 1050 °C under a  $\text{H}_2$  environment. Then, graphene was synthesized at 1050 °C under a  $\text{H}_2/\text{CH}_4$  (10/20 sccm) environment for 30 min and then the chamber was cooled down to room temperature with  $\text{H}_2$  gas (10 sccm) for 1 h. After the synthesis, the Cu foil was cut into small equal pieces ( $3 \times 3 \text{ cm}^2$ ). These small pieces of graphene on Cu foil were affixed on glass substrates using tape and the glass substrate was used as a holder for the graphene–Cu foil assembly.

An innovative ICP source, with dual mesh assembly inserted between source and substrate to prevent the bombardment of energetic ions on the graphene surface, has been demonstrated in a previous report.<sup>29</sup> The  $\text{Cl}_2$  plasma was generated under the conditions of 13.56 MHz, 20 W, 10 mTorr, and 60 sccm for 90–120 s. The graphene films, which were inserted in the chamber, were cooled down to 15 °C using a chiller.

The  $R_s$  values of the graphene films on PET and  $\text{SiO}_2$  were measured utilizing an  $R_s$  meter (Dasoleng, FPP-2400). UV spectroscopy (Shimadzu, 3600) was used to measure the optical characteristics of the graphene films with/without Cl trap-doping. To observe the Cl atoms between the graphene layers, a micro-EDS (energy dispersive X-ray spectroscopy) installed in the DF (dark field)-TEM (Transmission Electron Microscopy, FEI Titan 80/300) and scanning transmission electron microscopy-electron energy loss spectroscopy (STEM-EELS) were utilized. The Hall carrier mobility was measured using a Hall effect measurement system (HMS-3000, ECOPIA). Raman spectroscopy (Renishaw, RM-1000 Invia) with an excitation energy of 2.41 eV (514 nm,  $\text{Ar}^+$  ion laser) was used for the characterization of the graphene film trapped with Cl radicals.



## Acknowledgements

This research was supported by the Nano Material Technology Development Program through the National Research Foundation of Korea (NRF), funded by the Ministry of Education, Science and Technology (2016M3A7B4910429).

## Notes and references

- 1 K. S. Novoselov, A. K. Geim, S. V. Morozov, D. Jiang, Y. Zhang, S. V. Dubonos, I. V. Grigorieva and A. Firsov, *Science*, 2004, **306**, 666–669.
- 2 K. S. Novoselov, A. K. Geim, S. V. Morozov, D. Jiang, M. I. Katsnelson, I. V. Grigorieva, S. V. Dubonos and A. Firsov, *Nature*, 2005, **438**, 197–200.
- 3 C. R. Dean, A. F. Young, C. Lee, L. Wang, S. Sorgenfrei and K. Watanabe, *Nat. Nanotechnol.*, 2010, **5**, 722–726.
- 4 D. W. Brenner, O. A. Shenderova, J. A. Harrison, J. S. Sttuart, B. Ni and S. B. Sinnott, *J. Phys.: Condens. Matter*, 2002, **14**, 783–802.
- 5 C. Mattevi, H. W. Kim and M. Chhowalla, *J. Mater. Chem.*, 2011, **21**, 3324–3334.
- 6 H. Liu, Y. Liu and D. Zhu, *J. Mater. Chem.*, 2011, **21**, 3335–3345.
- 7 W. Chen, D. Qi, X. Gao and A. T. S. Wee, *Prog. Surf. Sci.*, 2009, **84**, 279–321.
- 8 S. M. Kim, A. Hsu, Y. H. Lee, M. Dresselhaus, T. Palacios, K. K. Kim and J. Kong, *Nanotechnology*, 2013, **24**, 365602.
- 9 F. Gunes, H. J. Shin, C. Biswas, G. H. Han, E. S. Kim, S. J. Chae, J. Y. Choi and Y. H. Lee, *ACS Nano*, 2010, **4**, 4595–4600.
- 10 J. Zheng, H. T. Liu, B. Wu, C. A. Di, Y. L. Guo, T. Wu, G. Yu, Y. Q. Liu and D. B. Zhu, *Sci. Rep.*, 2012, **2**, 662.
- 11 X. Zhang, A. Hsu, H. Wang, Y. Song, J. Kong, M. S. Dresselhaus and T. Palacios, *ACS Nano*, 2013, **7**, 7262–7270.
- 12 J. Wu, L. Xie, Y. G. Li, H. L. Wang, Y. Ouyang, J. Guo and H. Dai, *J. Am. Chem. Soc.*, 2011, **133**, 19668–19671.
- 13 B. Li, L. Zhou, D. Wu, H. Peng, K. Yan and Z. Liu, *ACS Nano*, 2011, **5**, 5957–5961.
- 14 S. Tongay, K. Berke, M. Lemaitre, Z. Nasrollani, D. B. Tanner, A. F. Hebard and B. R. Appleton, *Nanotechnology*, 2011, **22**, 425701.
- 15 N. Mcevoy, H. Nolan, N. A. Kumar, T. Hallam and G. S. Duesberg, *Carbon*, 2013, **54**, 283–290.
- 16 N. Peltekis, S. Kumar, N. Mcevoy, K. Lee, A. Weidlich and G. S. Duesberg, *Carbon*, 2012, **50**, 395–403.
- 17 P. Niranan, S. Marco, D. Alberto and A. Athanasia, *J. Mater. Sci.*, 2011, **46**, 5044–5049.
- 18 L. Xuelei, A. S. Brent, C. Irene, C. Guangjun, A. H. Christina, Z. Qin, O. Yaw, Y. Kai, P. Hailin, L. Qiliang, Z. Xiaoxiao, Z. Hui, R. H. W. Angela, L. Zhongfan, M. P. Lian and A. R. Curt, *ACS Nano*, 2011, **5**, 9144–9153.
- 19 Y. F. Xiao, N. Ryo, C. Y. Li and T. Katsumi, *Nanotechnology*, 2010, **21**, 475208.
- 20 C. Stephen, R. K. Peter and J. R. Preston, *J. Vac. Sci. Technol., B: Microelectron. Nanometer Struct.–Process., Meas., Phenom.*, 1996, **14**, 4129–4133.
- 21 A. M. Goosens, V. E. Calado, A. Barreiro, K. Watanabe, T. Taniguchi and L. M. K. Vandersypen, *Appl. Phys. Lett.*, 2012, **100**, 073110.
- 22 C. L. Yung, C. L. Chun, H. Y. Chao, J. Chuanhong, S. Kazu and W. C. Po, *Nano Lett.*, 2012, **12**, 414–419.
- 23 S. L. Wei, T. N. Chang and T. L. T. John, *Nano Lett.*, 2014, **14**, 3840–3847.
- 24 J. Moser, A. Barreiro and A. Batchtold, *Appl. Phys. Lett.*, 2007, **91**, 163513.
- 25 H. Micheal, B. Ryan and N. Lukas, *Phys. Lett. A*, 2013, **377**, 1455–1458.
- 26 H. Terrones, R. Lv, M. Terrones and M. Dresselhaus, *Rep. Prog. Phys.*, 2012, **75**, 062501.
- 27 D. L. Duong, G. H. Han, S. M. Lee, F. Gunes, E. S. Kim, S. T. Kim, Q. H. Ta, K. P. So, S. J. Yoon, S. J. Chae, Y. W. Jo, M. H. Park, S. H. Chae, S. C. Lim, J. Y. Choi and Y. H. Lee, *Nature*, 2012, **490**, 235–239.
- 28 G. H. Han, F. Gunes, J. J. Bae, E. S. Kim, S. J. Chae, H. J. Shin, J. Y. Choi, D. Pribat and Y. H. Lee, *Nano Lett.*, 2011, **11**, 4144–4148.
- 29 V. P. Pham, K. H. Kim, M. H. Jeon, S. H. Lee, K. N. Kim and G. Y. Yeom, *Carbon*, 2015, **95**, 664–671.
- 30 D. W. Brenner, O. A. Shenderova, J. A. Harrison, J. S. Sttuart, B. Ni and S. B. Sinnott, *J. Phys.: Condens. Matter*, 2002, **14**, 783.
- 31 H. Wang and G. Yu, *Adv. Mater.*, 2016, **28**, 4956–4975.
- 32 M. Chen, H. Zhou, C. Qiu, H. Yang, F. Yu and L. Sun, *Nanotechnology*, 2012, **23**, 115706.
- 33 S. De and J. Coleman, *ACS Nano*, 2010, **4**, 2713–2720.
- 34 R. R. Nair, P. Blake, A. N. Grigorenko, K. S. Novoselov, T. J. Booth, T. Stauber, N. M. R. Peres and A. K. Geim, *Science*, 2008, **320**, 1308.
- 35 K. Suzuki, I. Nishiyama, Y. Ozaki and K. Kuchitsu, *Chem. Phys. Lett.*, 1978, **58**, 145–148.
- 36 J. B. Nee, *Chin. J. Phys.*, 1988, **26**, 254–261.
- 37 H. A. Bechtel, J. P. Candan, D. J. A. Brown, M. R. Martin, R. N. Zare and K. Vodopyanov, *Angew. Chem., Int. Ed.*, 2005, **44**, 2382–2385.
- 38 D. A. C. Brownson and C. Banks, *Phys. Chem. Chem. Phys.*, 2012, **14**, 8264–8281.

